Universal Serial Bus
Device Class Definition
for
Video Devices:
DV Payload

Revision 1.1

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## **Revision History**

Version	Date	Description
1.0	September 4, 2003	Initial release
1.1	June 1 <sup>st</sup> , 2005	Corrected SCR definition for DV Payload (RR0023)
		Clarifications in SCR definition
		Support for multiple clock frequencies (RR0033)
		RTP Reference Removal (RR0065).
		Deprecated the field dwMaxVideoFrameBufferSize in Table
		3-1. (RR0064)

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### 1 Introduction

### 1.1 Purpose

This document defines the DV payload format for devices that are compliant with the *USB Device Class Definition for Video Devices* document.

#### 1.2 Scope

The payload format and associated header information is fully specified in this document. This includes:

- USB Video Class stream header
- Payload-specific header
- Error detection and recovery

#### 1.3 Related Documents

USB Specification Revision 2.0, April 27, 2000, www.usb.org

USB Device Class Definition for Video Devices, www.usb.org

*IEC61834-1 Recording* - Helical-scan digital video cassette recording system using 6,35 mm magnetic tape for consumer use (525-60, 625-50, 1125-60 and 1250-50 systems) - Part 1: General specifications.

*IEC61834-2 (1998-08)* Recording - Helical-scan digital video cassette recording system using 6,35 mm magnetic tape for consumer use (525-60, 625-50, 1125-60 and 1250-50 systems) - Part 2: SD format for 525-60 and 625-50 systems.

*IEC61834-3 (1999-11)* Recording - Helical-scan digital video cassette recording system using 6,35 mm magnetic tape for consumer use (525-60, 625-50, 1125-60 and 1250-50 systems) - Part 3: HD format for 1125-60 and 1250-50 systems.

*IEC61834-6 (2000-08)* Recording - Helical-scan digital video cassette recording system using 6,35 mm magnetic tape for consumer use (525-60, 625-50, 1125-60 and 1250-50 systems) - Part 6: SDL format.

IEC 61883-1: Consumer Audio/Video Equipment-Digital Interface –Part 1: General.

*IEC 61883-2:* Consumer Audio/Video Equipment-Digital Interface –Part 2: SD-DVCR Data Transaction.

*IEC 61883-3:* Consumer Audio/Video Equipment - Digital Interface - Part 3: HD-DVCR Data Transmission

*IEC 61883-5:* Consumer Audio/Video Equipment - Digital Interface - Part 5: SDL-DVCR Data Transmission

#### 1.4 Terms and Abbreviations

The following table defines terms and abbreviations used throughout this document.

Term Description				
ADU	Application data unit			
UVC	USB Video Class			
SD-DV	Standard definition digital video			
SDL-DV	Standard definition digital video for high compression mode			
HD-DV	High definition digital video			

525-60 system	525-line system with a frame frequency of 29.97 Hz
625-50 system	625-line system with a frame frequency of 25.00 Hz
1125-60system	1125-line system with a frame frequency of 30.00 Hz
1250-50system	1250-line system with a frame frequency of 25.00 Hz

### **2** Video Class-Specific Information

### 2.1 Compression Class

This specification describes the following three classes, SD-DV, SDL-DV, and HD-DV class, which are based on IEC 61834-2 Clause 11(SD), -3 Clause 10 (HD), and -6 Clause 10(SDL). Throughout this specification, we will make extensive use of the ISOIEC/ standards terminology. The reader should consult the original references mentioned in section 1.3 "Related Documents" for definitions of these terms.

The USB isochronous payload consists of the header block and the source data block. The header block definition of a DV stream is described in section 2.2 "Stream Header". The source data blocks are placed into the USB isochronous payload immediately after the DV stream header block.

A frame of DV format data is divided into several DIF block sequences. A DIF sequence consists of a number of DIF blocks in 80 bytes. There are five types of DIF blocks:

- DIF sequence header
- Subcode
- Video auxiliary information (VAUX)
- Audio
- Video

The relationship between each DIF block/DIF sequence and the source data blocks in the USB isochronous payload for the 525-60 system and the 625-50 system are described in section 3.2 "Video Samples".

The source data block size in payload for the SD-DV class is 480 bytes fixed size, and consists of 6 DIF blocks.

The source data block size in payload for the SDL-DV class is 240 bytes fixed size, and consists of 3 DIF blocks.

The source data block size in payload for the HD-DV class is 960 bytes fixed size, and consists of 12 DIF blocks.

#### 2.2 Stream Header

The following is description of the header for DV format.

BFH[0]: Bit Field Header

- o FID: Frame ID
- o EOF: End of Frame
- o PTS: Presentation Time Stamp
- o SCR: Source Clock Reference
- o RES: Reserved
- o STI: Still Image
- o ERR: Error Bit
- o EOH: End of Header

USB VC header definition for DV format.

**Table 2-1 VC Header Definition for DV Format** 

### HLE BFH [0]

Header Length									
ЕОН	EOH ERR STI RES SCR PTS EOF FID								
			PTS [	7:0]					
			PTS [	15:8]					
			PTS [2	3:16]					
			PTS[3	1:24]					
			SCR	[7:0]					
			SCR [	15:8]					
			SCR [2	23:16]					
SCR [31:24]									
	SCR [39:32]								
			SCR [4	7:40]	·				

Header Length: Size: 1Byte, Value: unit number in bytes

The header length field specifies the length of the header, in bytes.

FID: Frame ID

This ID should toggle between 0 and 1 for successive DV frames.

EOF: End of Frame

This term has no meaning in DV class. It shall be set to zero.

PTS: Presentation Time Stamp

This flag shall be set to one when this payload header contains the 4-byte PTS field.

SCR: Source Clock Reference

This flag shall be set to one when this payload header contains the 6-byte SCR field.

RES: Reserved

This flag shall be set to zero.

STI: Still Image

This flag shall be set to zero.

ERR: Error Bit

This flag shall be set to one when there is an error in the payload.

EOH: End of Header

This flag shall be set to one.

PTS: Presentation Time Stamp, Size: 4 bytes, Value: Number

For DV applications PTS indicates the time (based on STC) at which each video frame period begins, which is used for synchronizing the video frame frequency between media transport mechanisms of the transmitter and the receiver.

The transmitter shall transmit a PTS field once every video frame period and only with the first source data block (n = 0) of a video frame.

The PTS value shall indicate at most 450 µs in the future relative to the STC when it is generated at the transmitter.

SCR: Source Clock Reference, Size: 6 bytes, Value: Number

The format and value of the SCR shall be as defined in the *USB Device Class Definition for Video Devices* document. The resolution of the STC field (D31..D0) of the SCR shall be based on the 13.5 MHz clock, and the device shall set the **dwClockFrequency** field of the Video Probe Control response to 0x00CDFE60 (which represents 13.5 MHz) when the DV payload format is selected by the host. The SCR values are used for synchronizing timing information between the transmitter and the receiver, and shall be sent at least every 100 ms.

### 3 Payload-Specific Information

### 3.1 Descriptors

### 3.1.1 DV Format Descriptor

The DV Format Descriptor defines the characteristics of a specific DV stream. A Terminal corresponding to a USB IN or OUT endpoint, and the interface it belongs to, supports one or more format definitions. To select a particular format, host software sends control requests to the corresponding interface.

DV format streams must support the Presentation Time and Source Clock fields in the packet header. DV Format Descriptors have no accompanying Frame Descriptors.

A DV Format Descriptor identifies the following:

**Table 3-1 DV Format Descriptor** 

Offset	Field	Size	Value	Description
0	bLength	1	Number	Size of this Descriptor, in bytes: 9
1	bDescriptorType	1	Constant	CS INTERFACE Descriptor type
2	bDescriptorSubtype	1	Constant	VS FORMAT DV Descriptor
				subtype
3	bFormatIndex	1	Number	Index of this Format Descriptor
4	dwMaxVideoFrameBufferSize	4	Number	Use of this field has been
				deprecated.
				Specifies the maximum size of a single DV frame, in bytes. This will vary according to the format (SD/SDL/HD) and standard (NTSC/PAL).
				The dwMaxVideoFrameSize field of the Video Probe and Commit control replaces this descriptor field. A value for this field shall be chosen for compatibility with host software that implements an earlier version of this specification.
8	bFormatType	1	Number	D7: 0 = 50 Hz, 1 = 60 Hz D60: 0: SD-DV 1: SDL-DV 2: HD-DV All other values are reserved.

### 3.2 Video Samples

The scope of this specification is the following video format based on IEC 61834, in Parts 2, 3, and 6. All the DIF blocks specified in IEC 61834 include the DV system data. DV streaming has DV system data into "source" and "source control" packs in a DIF block, such as aspect ratio, picture position, quantization of audio sampling, number of audio channels and so on. It will be transmitted via isochronous streaming data. Therefore, this information is not included in this specification.

### 3.2.1 Source Blocks in a Data Payload of SD-DV 525-60 System in a Frame

0	H <sub>0</sub>	SC0	SC1	VAo	VA1	VA2	
1 :	Ao	Vo	$V_1$	$V_2$	<i>V</i> <sub>3</sub>	$V_4$	DIF
•	<b>-</b>	_	:	T	T	T	sequence 0
23	V123	$V_{124}$	$V_{125}$	V126	$V_{127}$	$V_{128}$	sequence o
24	V129	V130	V131	V132	V133	V134	J
25	$H_0$	SC0	SC1	VA0	VA1	VA2	ገ DIF
:							sequence 1
49	V129	V130	V131	$V_{132}$	V133	V134	J .
225			:	:			
225	$H_0$	SC0	SC1	$VA_0$	VA1	VA2	DIF
249	:						sequence 9
21)	$V_{129}$	V130	$V_{131}$	V132	V133	V134	٠ -

*Hi*: *Header DIF block* 

*Sci* :*Subcode DIF block I (I=0,1)* 

 $VAi:VAUX\,DIF\,\,block\,I\,\,(I=0,1,2)$ 

 $A_i$ : Audio DIF block I(I=0..8)

### 3.2.2 Source Blocks in a Data Payload of SD-DV 625-50 System in a Frame

0	$H_0$	SC0	SC1	VA0	VA1	VA2	
1	Ao	Vo	$V_1$	$V_2$	$V_3$	$V_4$	
÷				:			sequence 0
23	V123	$V_{124}$	V125	V126	V127	V128	sequence o
24	V129	V130	V131	V132	V133	V134	
25	$H_0$	SC0	SC1	VAo	VA1	VA2	DIF
Ī				:			sequence 1
49	V129	$V_{130}$	V131	V132	V133	V134	'
į				:			
275			T-	•			— ) DIE
275	$H_0$	SCo	SC1	VAo	$VA_1$	$VA_2$	DIF
200				:			sequence
299	V129	$V_{130}$	V131	V132	V133	V134	

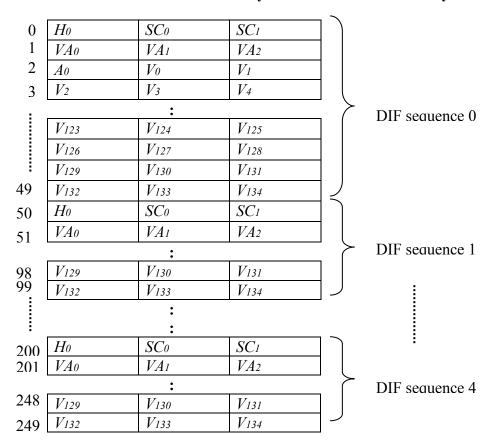
Hi: Header DIF block

Sci:Subcode DIF block I (I=0,1)

VAi: VAUX DIF block I (I=0,1,2)

Ai: Audio DIF block I(I=0..8)

### 3.2.3 Source Blocks in a Data Payload of SDL-DV 525-60 System in a Frame



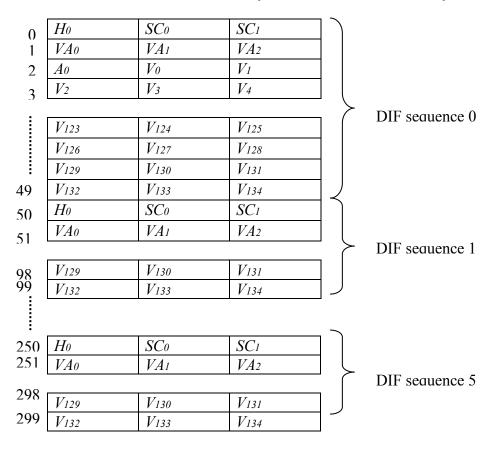
*Hi*: *Header DIF block* 

*Sci*:Subcode DIF block I (I=0,1)

VAi: VAUX DIF block I (I=0,1,2)

*Ai*: Audio DIF block I(I=0..8)

### 3.2.4 Source Blocks in a Data Payload of SDL-DV 625-50 System in a Frame



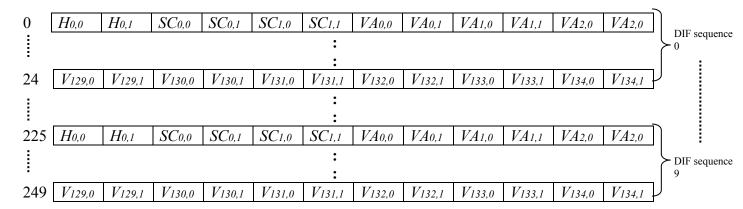
*Hi: Header DIF block* 

Sci:Subcode DIF block I (I=0,1)

 $VAi: VAUX DIF \ block \ I \ (I=0,1,2)$ 

Ai: Audio DIF block I(I=0..8)

### 3.2.5 Source Blocks in a Data Payload of 1125-60 System in a Frame



 $H_{0,k}$ : Header DIF block 0, section k (k=0,1)

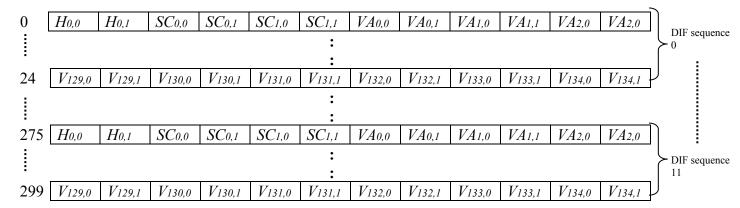
Scik: Subcode DIF block i, section k (i=0,1), section k (k=0,1)

 $VA_{ik}$ : VAUX DIF block i, section k (i=0,1,2), section k (k=0,1)

Aik: Audio DIF block i, section k (i=0..8), section k (k=0,1)

 $V_{ik}$ : Video DIF block i, section k (i =0..134), section k (k=0,1)

#### 3.2.6 Source Blocks in a Data Payload of 1250-50 System in a Frame



 $H_{0,k}$ : Header DIF block 0, section k (k=0,1)

Scik: Subcode DIF block i, section k (i=0,1), section k (k=0,1)

 $VAik:VAUX\ DIF\ block\ i,\ section\ k\ (i=0,1,2),\ section\ k\ (k=0,1)$ 

Aik: Audio DIF block i, section k (i=0..8), section k (k=0,1)

 $V_{ik}$ : Video DIF block i, section k (i =0..134), section k (k=0,1)

#### 3.2.7 Payload Transmission Timing in DV Format

This section specifies the transmission timing of each packet to reduce buffer size.

The transmitter shall never pad the source data packet in a frame interval time, even if the maximum bit rate would be satisfied in the Video Frame Descriptor described. The source data block n of video frame M shall be transmitted in a packet, which meets the following conditions:

Nominal timing for the source data block  $n = T_M + (T_{M+1} - T_M) * n/K$   $T_M$  is the time stamp for video frame M transmitted in the PTS field. n=0..K-1

K=250 (525-60 system and 1125-60 system)

K=300 (625-50 system and 1250-50 system)

### 4 Examples

### 4.1 Isochronous Transfer IN

The following example shows the relationship between Payload Transfers, the token and data packets when receiving isochronous transfers from the device. This example shows high-speed, high-bandwidth transfers of the DV stream format. payload format. The actual bandwidth usage will vary according to the requirements of the device.

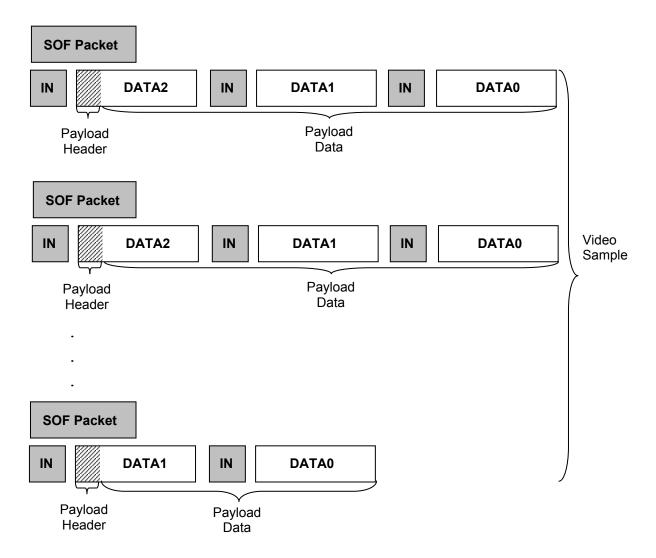


Figure 4-1 Example DV Isochronous Transfer, IN Endpoint

### 4.2 Isochronous Transfer OUT

The following example shows the relationship between Payload Transfers, the token and data packets when sending isochronous transfers to the device. This example shows high-speed, high-bandwidth transfers of the DV payload format. The actual bandwidth usage will vary according to the requirements of the device.

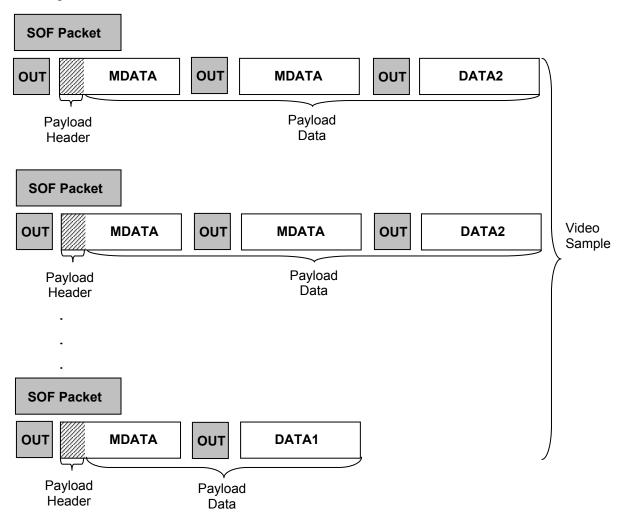


Figure 4-2 Example DV Isochronous Transfer, OUT Endpoint

### 4.3 Bulk Transfer IN

The following example shows the relationship between Video Samples, Payload Transfers and the token and data packets of the DV payload format when receiving bulk transfers from a device. Handshake packets are not shown for the sake of clarity.

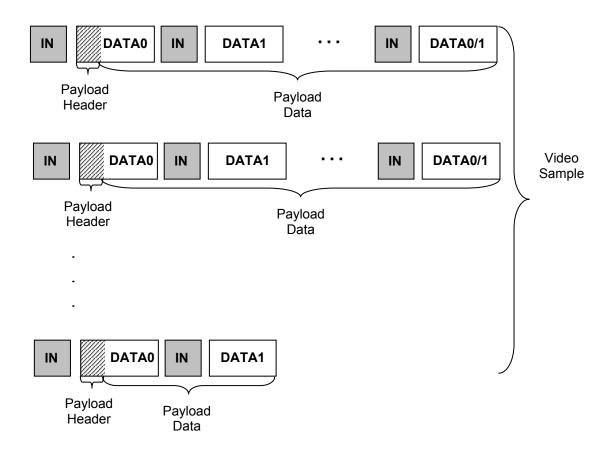


Figure 4-3 Example DV Bulk Transfer, IN Endpoint

### 4.4 Bulk Transfer OUT

The following example shows the relationship between Video Samples, Payload Transfers and the token and data packets of the DV payload format when sending bulk transfers to the device. Handshake packets are not shown for the sake of clarity.

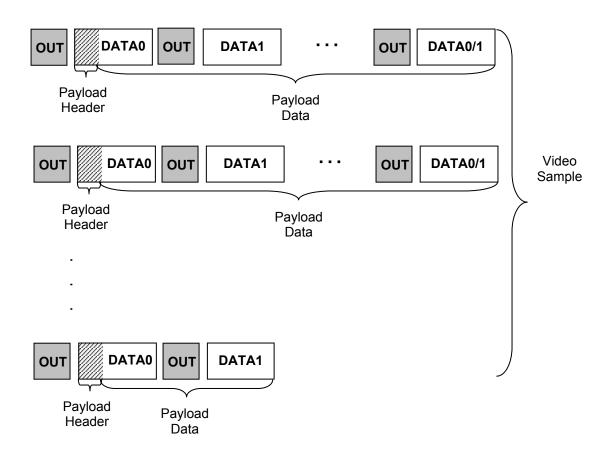


Figure 4-4 Example DV Bulk Transfer, OUT Endpoint